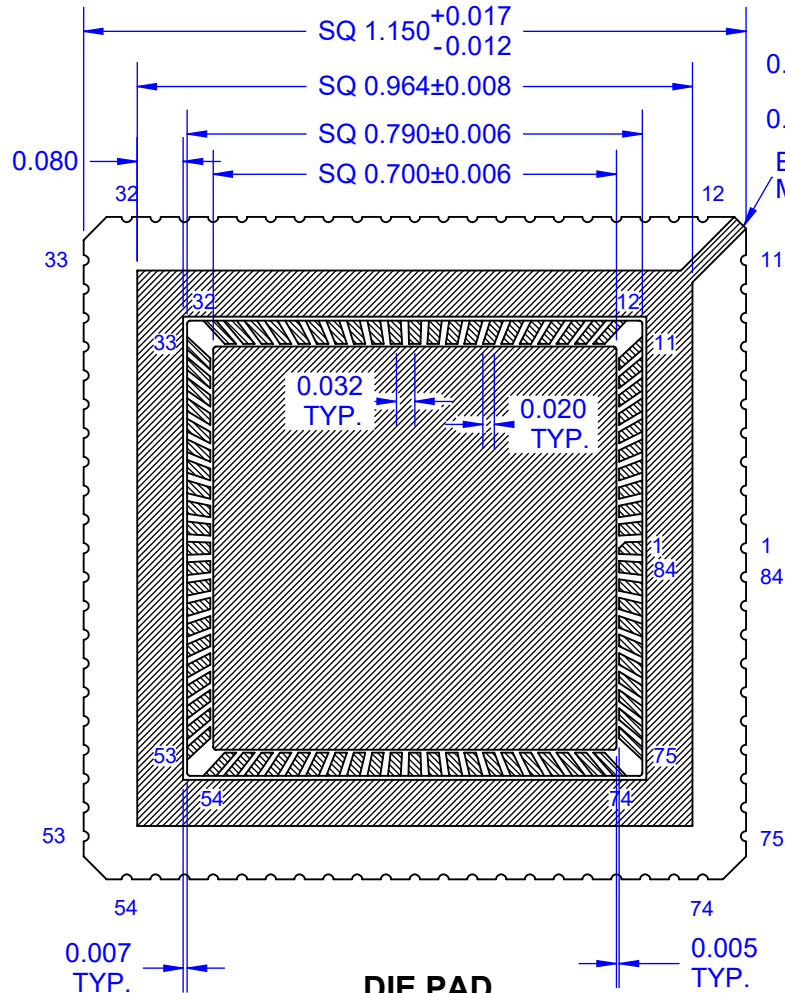
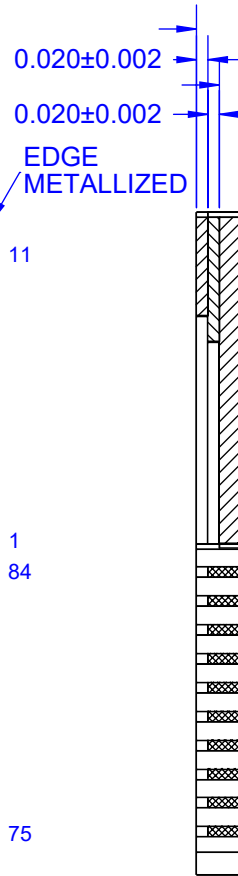


TOP VIEW

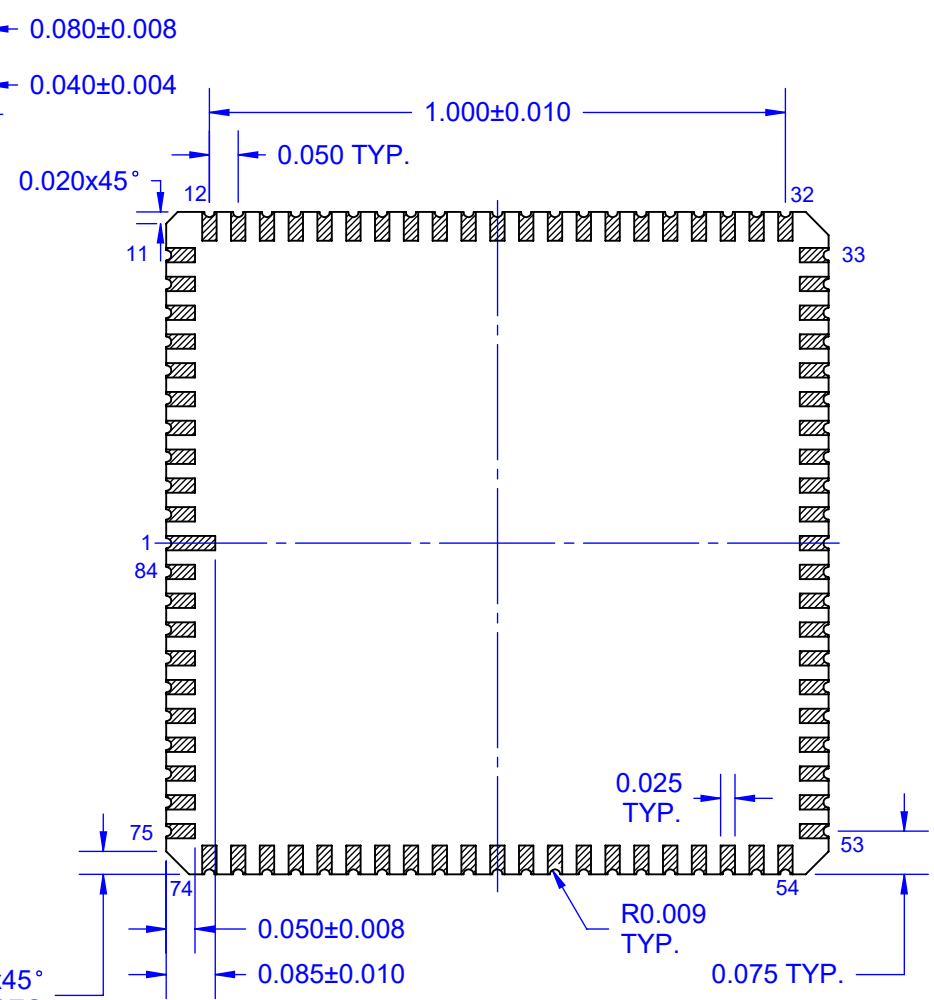


DIE PAD
0.700 x 0.700-inch
[17.78 x 17.78mm]

SIDE VIEW



BOTTOM VIEW



NOTES: (Unless Otherwise Specified).

1. DIMENSION in INCH.

2. PLATING:

Ni = NONE.

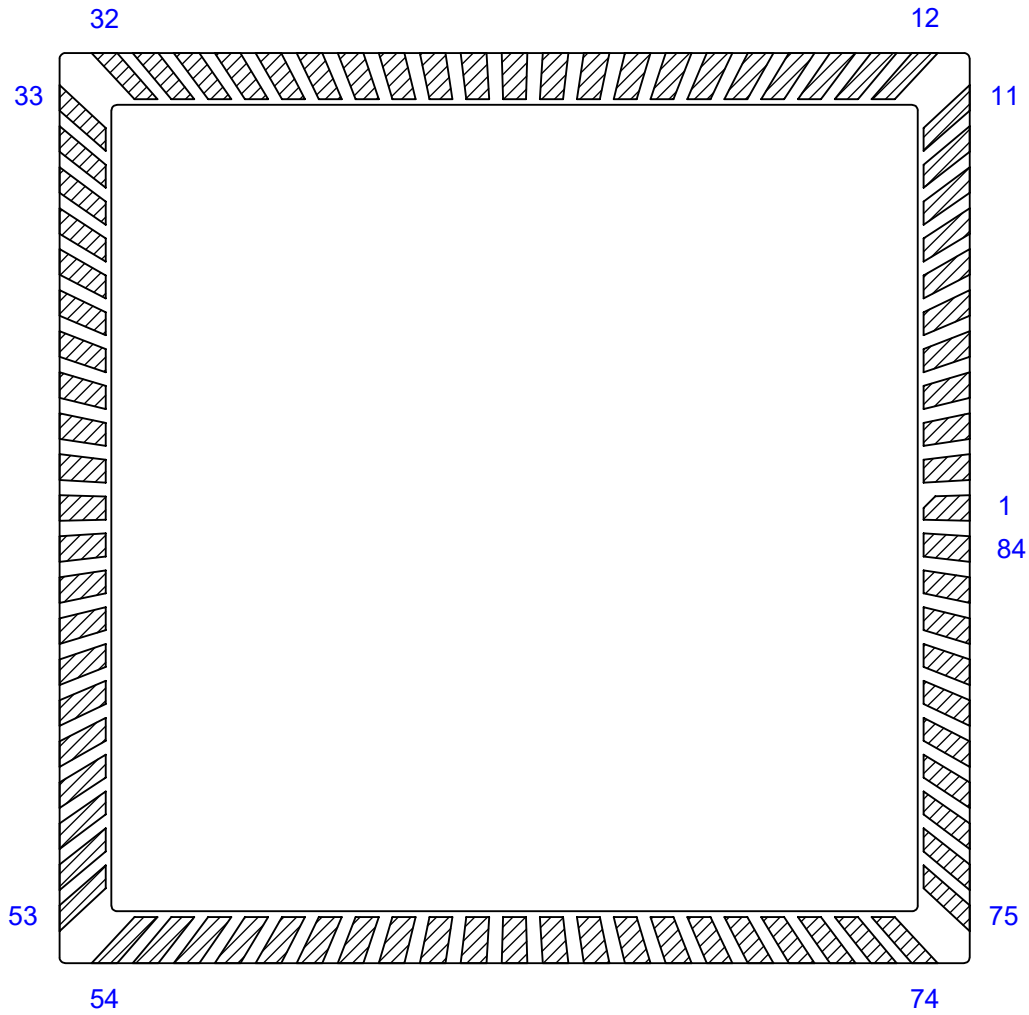
Au 20 MICRO-INCH (0.5µm) MIN.

3. SEAL RING AND DIE ATTACH SHALL BE ISOLATED FROM ALL LEADS.

4. NOT ZERO TESLA.

APPROVALS	DATE	TopLine®			
DRAWN T. Au	5/15/2022				
ENG M. Hart	5/15/2022	TITLE LCC84B50SQ.1.15-NM700 NON-MAGNETIC			
MFG		SCALE	SIZE	DRAWING NO.	REV
QA		10:1	A	148402	A
CUST		DO NOT SCALE DRAWING			SHEET 1 OF 4
REVISED					

BOND PAD DIAGRAM



TopLine®

TITLE LCC84B50SQ.1.15-NM700
NON-MAGNETIC

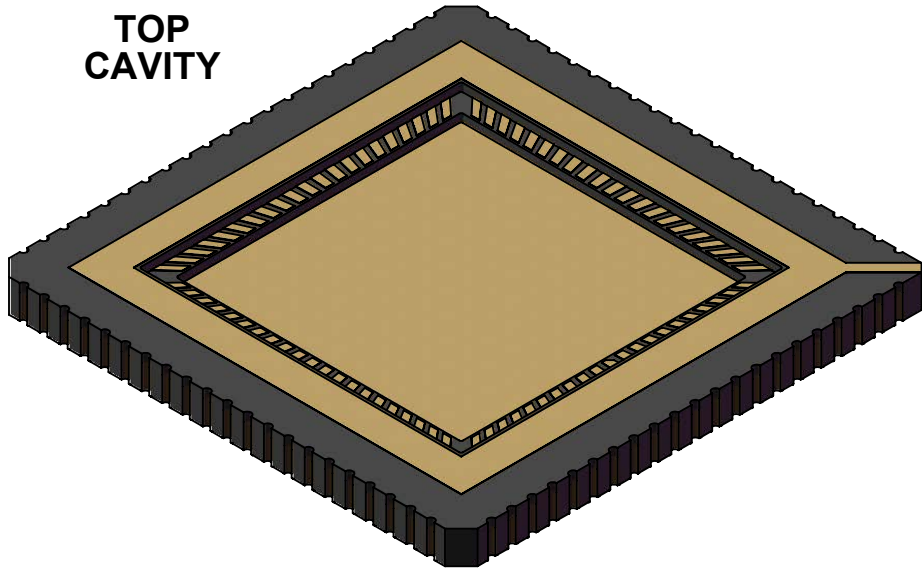
SCALE 6:1	SIZE A	DRAWING NO. 148402	REV A
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DO NOT SCALE DRAWING

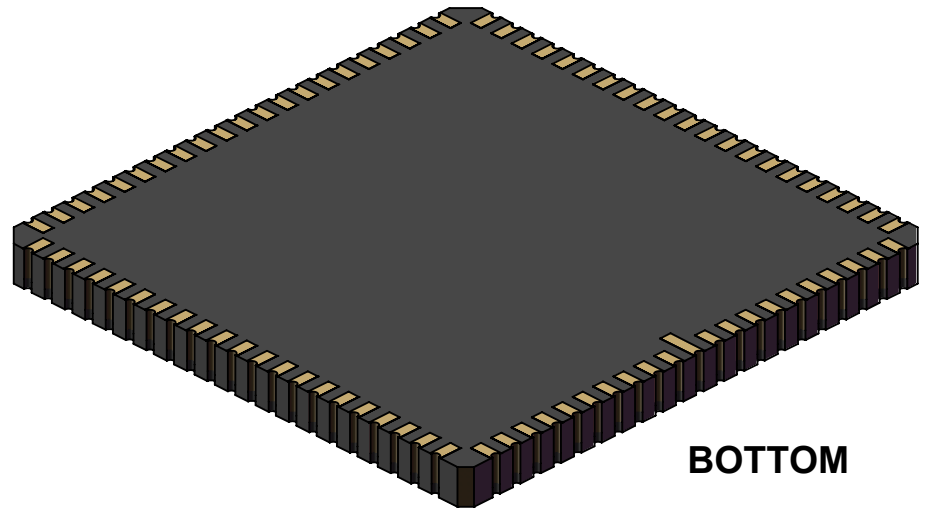
SHEET 2 OF 4

MODEL

TOP
CAVITY



BOTTOM



TopLine[®]

TITLE LCC84B50SQ.1.15-NM700
NON-MAGNETIC

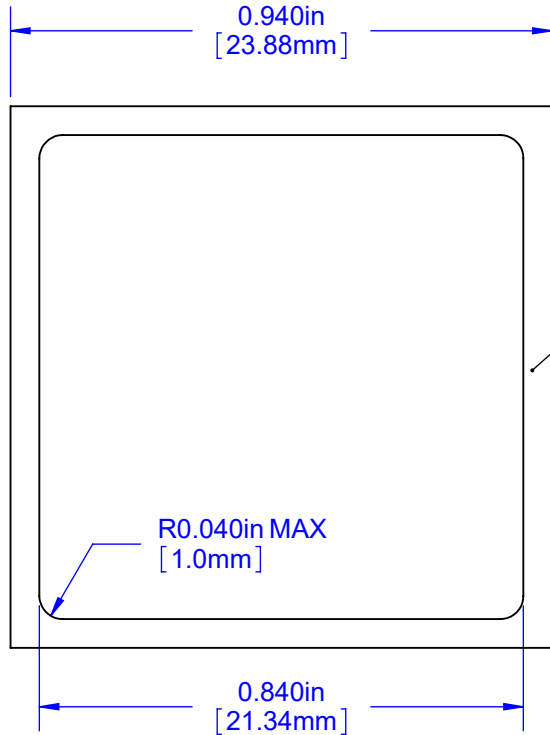
SCALE 3:1	SIZE A	DRAWING NO. 148402	REV A
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DO NOT SCALE DRAWING

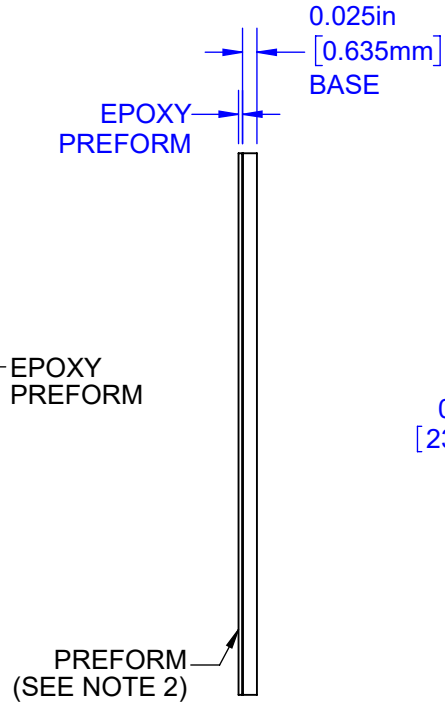
SHEET 3 OF 4

CERAMIC LID (OPTIONAL) WITH EPOXY PREFORM

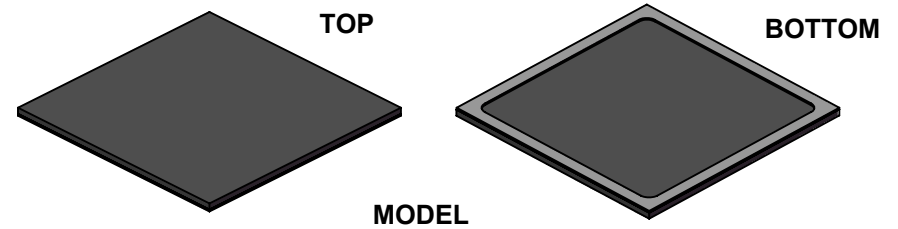
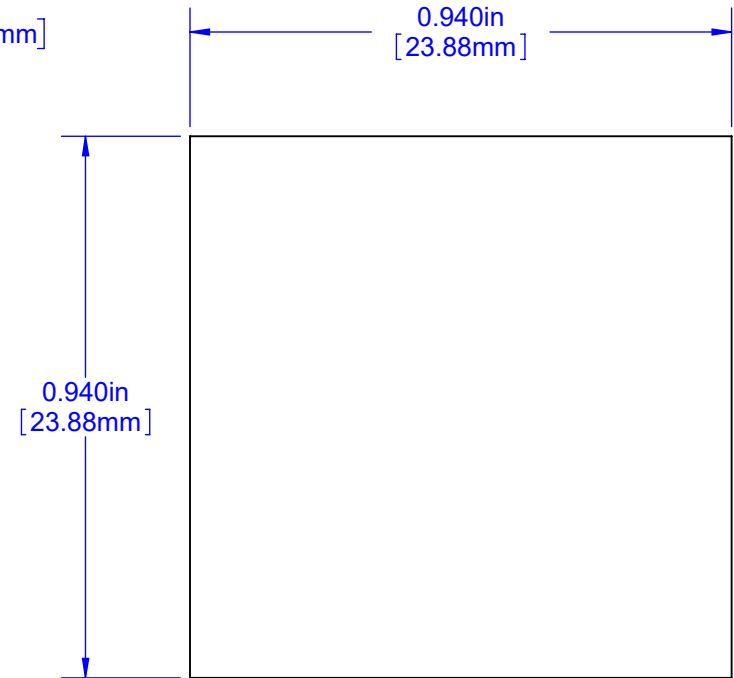
BOTTOM



SIDE



TOP



NOTES:

1. BASE MATERIAL: BLACK CERAMIC Al_2O_3 .
2. Epoxy Preform (B-STAGE) Thickness: 0.003~0.007in [0.076~0.18mm].
3. TOLERANCE: ± 0.005 in (0.127mm).

TopLine[®]

TITLE B-CLID-940-A
CERAMIC LID WITH EPOXY PREFORM

SCALE 3:1	SIZE A	DRAWING NO. 148402	REV A
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DO NOT SCALE DRAWING

SHEET 4 OF 4